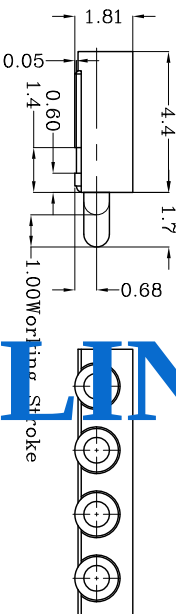
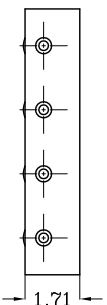
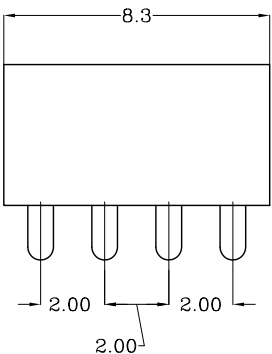
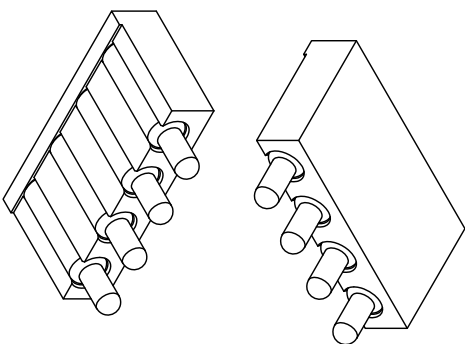
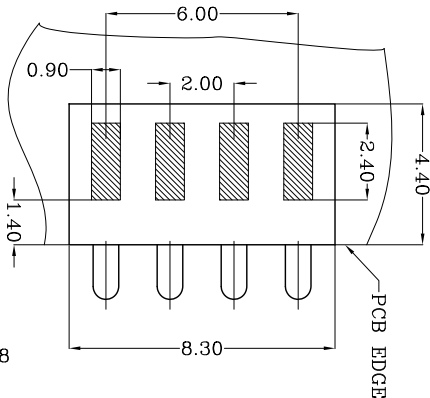


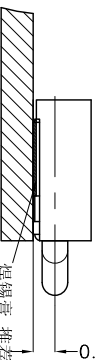
DWG NO.
C-100001



Preventing Stroke

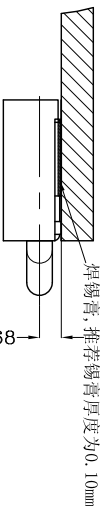


PCB EDGE



焊锡膏, 推荐锡膏厚度为0.10mm

IMPORTANT: The recommended thickness of solder paste is 0.10mm



—焊锡膏, 推荐锡膏厚度为0.10mm

Notes:

Material(材质):

Housing: LCP C

Contact: Brass

Spring : Stainless steel wire

2 Plating

1)Body: Min 0.1um Gold plating over min. 1.4um Nickel plating

(Body: 鍍金0.1μm Min 鍍底1.4μm Min)

2)Plunger: Min 0.4um Gold plating over min. 1.4um Nickel plating

(Plunger: 鍍金0.4um Min 鍍底1.4um Min)

3 Mechanical:

Spring force: Min 0.2N with 0.3mm stroke

1.1 $+0.30\text{N}/-0.20\text{N}$ with 1.0mm stroke

Total stroke(总行程): 1.40mm

Durability(寿命): 10,000 cycle min.

DIMENSIONS IN MM TOLERANCES UNLESS OTHER SPECIFIED				
0	= ±			
0.0	= ±0.10			
0.00	= ±			
0.000	= ±			
ANGLE: ±1°				
SURF TEXTURE: 3.2/ V				
REMOVE BURRS, BREAK SHARP EDGES, ROUNDS MAX				
DO NOT SCALE PRINT				
MATL	△1	HT TR	—	FIN
DVN		APVD		
Qln			Top-Link Electronics	Top-Link Electronics Ltd.
CHK		REL		
NAME BATTERY PGC-1.36-6.1-RA-4P-2.0PH CONNECTOR 4 POSITIONS RIGHT ANGLE				
SCALE	A4	DWG NO.	C-100001	SHEET 1 OF 1
	1:1			REV E

USED ON

100001-4

PART NUMBER

A

W

D